

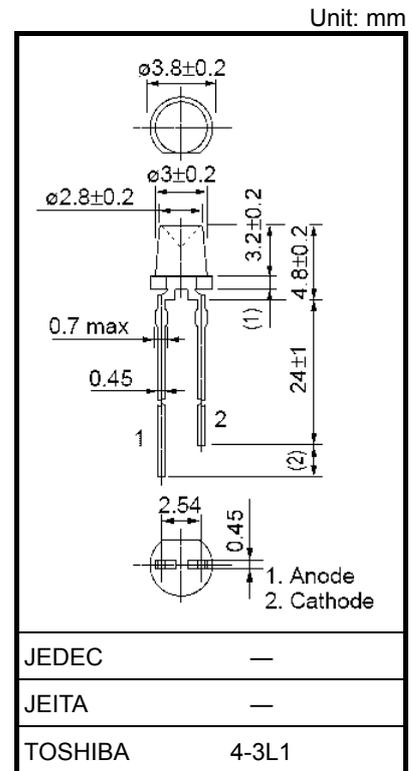
# TLRE60T(F), TLOE60T(F), TLYE60T(F), TLGE60T(F)

## Panel Circuit Indicators

- 3-mm package
- InGaA&P
- Plastic-molded
- Transparent lens
- Available in 4 colors: red, orange, yellow and green
- luminous intensity
- Excellent low-current light output
- Wide radiation pattern
- Application: backlighting

## Product List

Part Number	Color	Material
TLRE60T(F)	Red	InGaA/P
TLOE60T(F)	Orange	
TLYE60T(F)	Yellow	
TLGE60T(F)	Green	



## Absolute Maximum Ratings (Ta = 25°C)

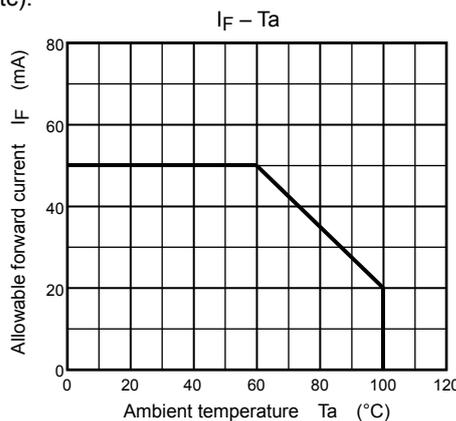
Weight: 0.12 g (typ.)

Part Number	Forward Current I <sub>F</sub> (mA)	Reverse Voltage V <sub>R</sub> (V)	Power Dissipation P <sub>D</sub> (mW)	Operating Temperature T <sub>opr</sub> (°C)	Storage Temperature T <sub>stg</sub> (°C)
TLRE60T(F)	50	4	120	-40 to 100	-40 to 120
TLOE60T(F)					
TLYE60T(F)					
TLGE60T(F)					

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook (“Handling Precautions”/“Derating Concept and Methods”) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Forward current derating



## Electrical and Optical Characteristics (Ta = 25°C)

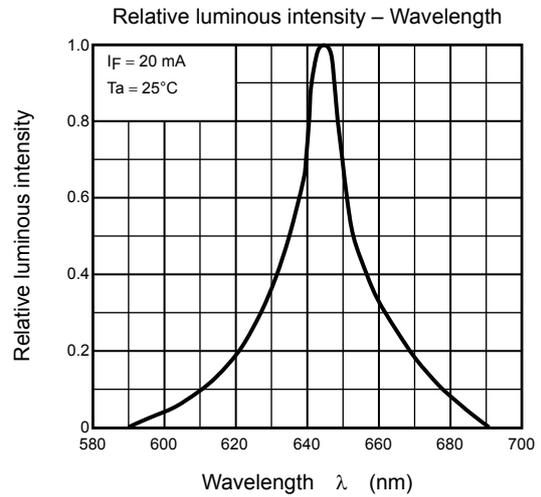
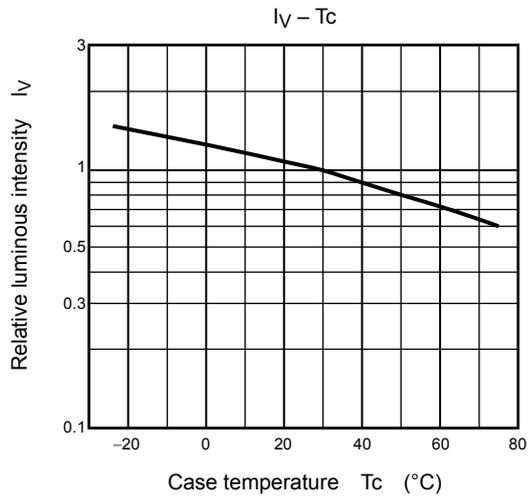
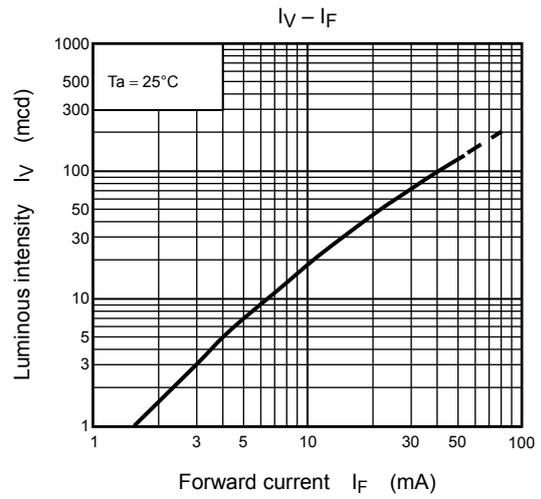
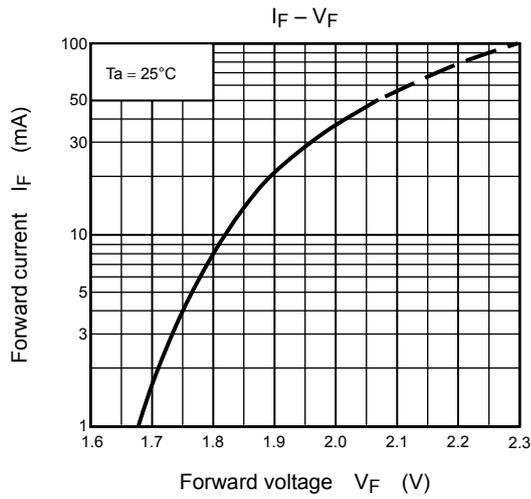
Part Number	Typ. Emission Wavelength				Luminous Intensity I <sub>V</sub>			Forward Voltage V <sub>F</sub>			Reverse Current I <sub>R</sub>	
	λ <sub>d</sub>	λ <sub>p</sub>	Δλ	I <sub>F</sub>	Min	Typ.	I <sub>F</sub>	Min	Typ.	I <sub>F</sub>	Max	V <sub>R</sub>
TLRE60T(F)	630	644	20	20	15.3	45	20	1.9	2.4	20	50	4
TLOE60T(F)	605	612	20	20	27.2	100	20	2.0	2.4	20	50	4
TLYE60T(F)	587	590	17	20	27.2	85	20	2.0	2.4	20	50	4
TLGE60T(F)	571	574	17	20	15.3	50	20	2.0	2.4	20	50	4
Unit	nm			mA	mcd		mA	V		mA	μA	V

## Precautions

Please be careful of the following:

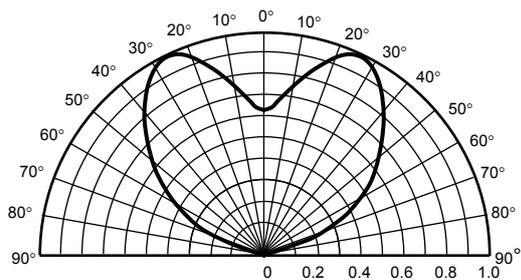
- Soldering temperature: 260°C max, soldering time: 3 s max  
(soldering portion of lead: up to 1.6 mm from the body of the device)
- If the lead is formed, the lead should be formed up to 1.6 mm from the body of the device without forming stress to the resin. Soldering should be performed after lead forming.
- This visible LED lamp also emits some IR light.  
If a photodetector is located near the LED lamp, please ensure that it will not be affected by this IR light.

## TLRE60T(F)

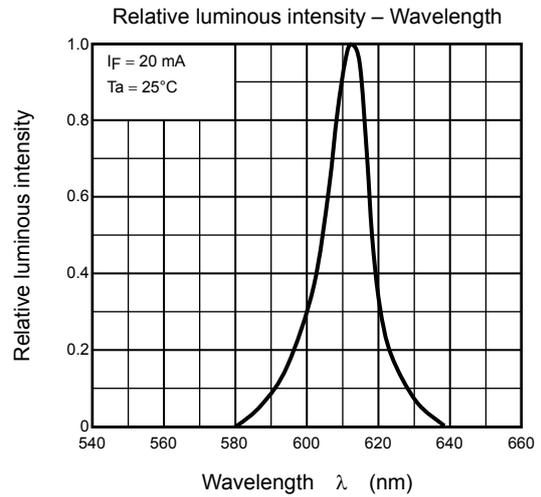
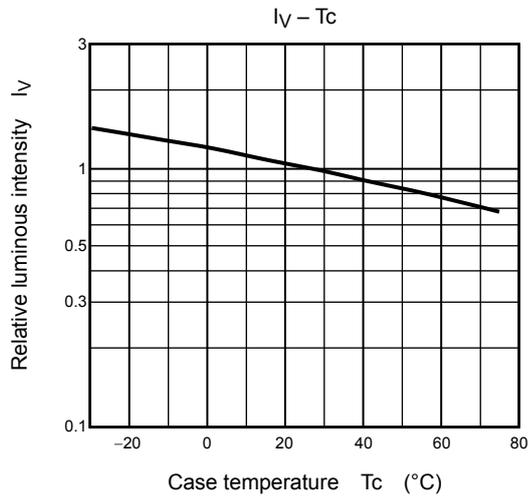
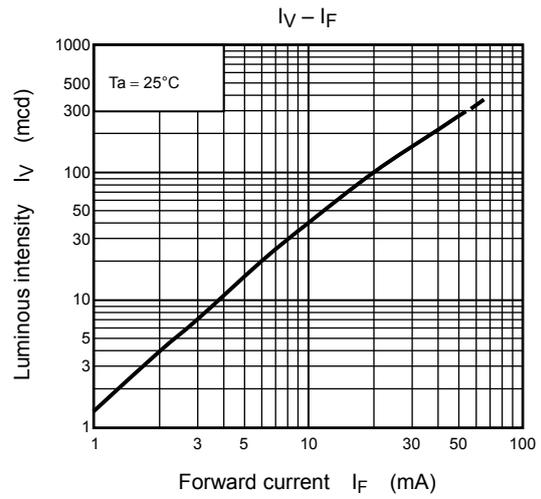
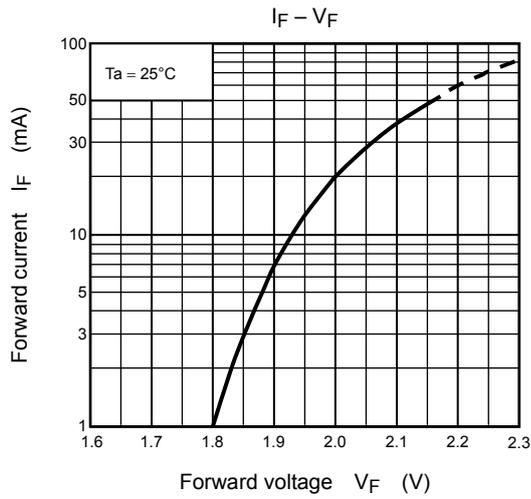


### Radiation pattern

$T_a = 25^\circ\text{C}$

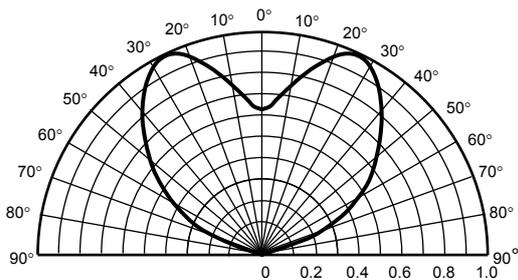


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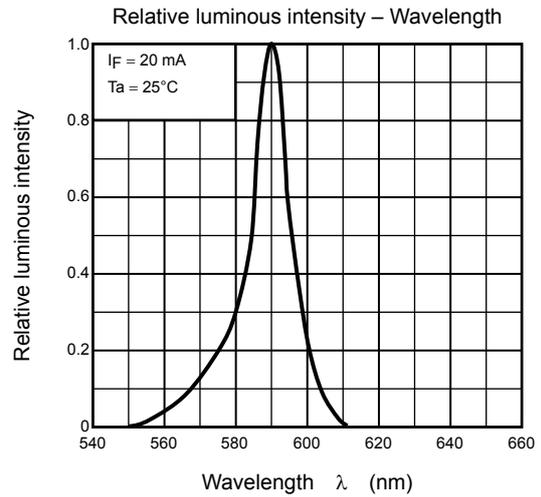
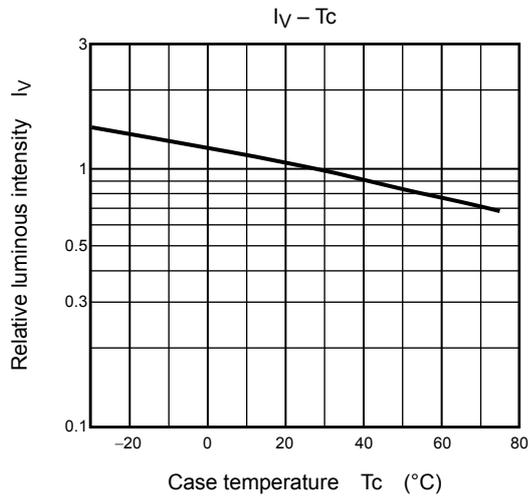
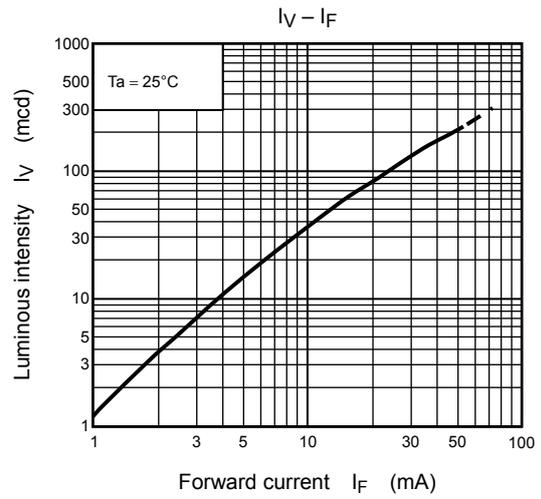
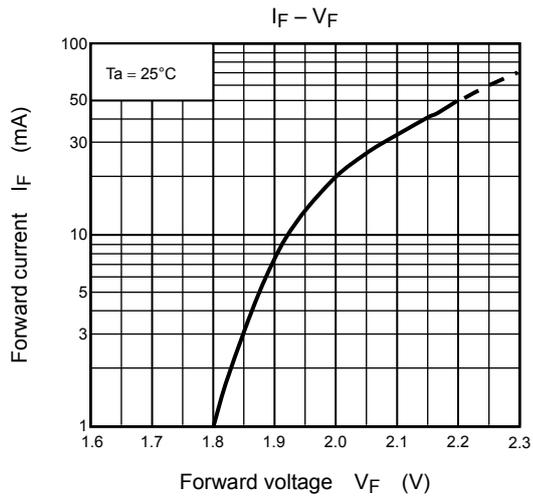


### Radiation pattern

$T_a = 25^\circ\text{C}$

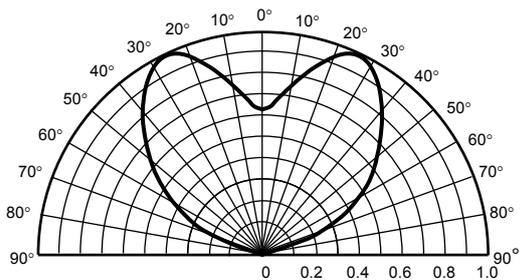


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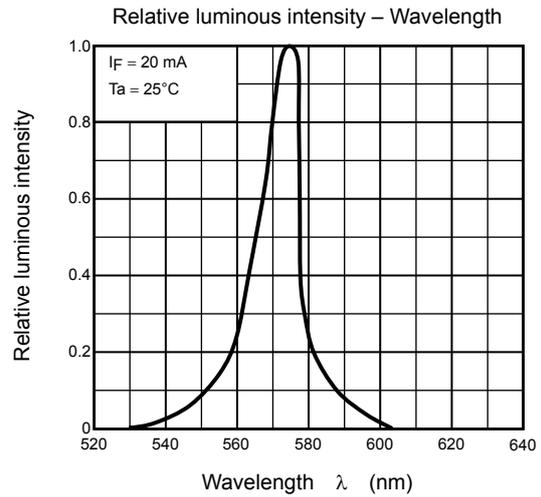
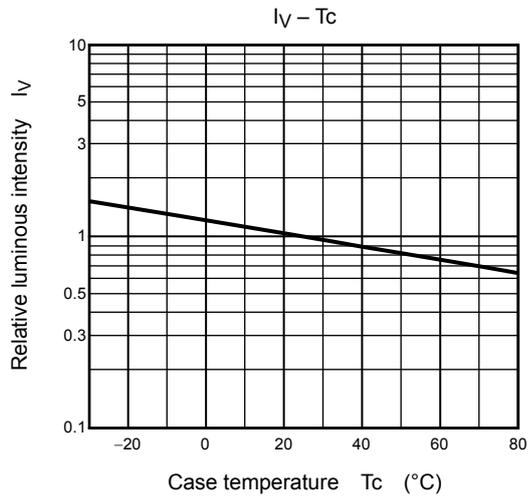
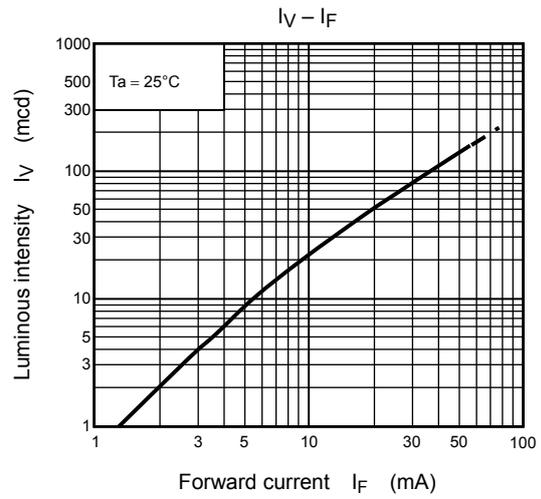
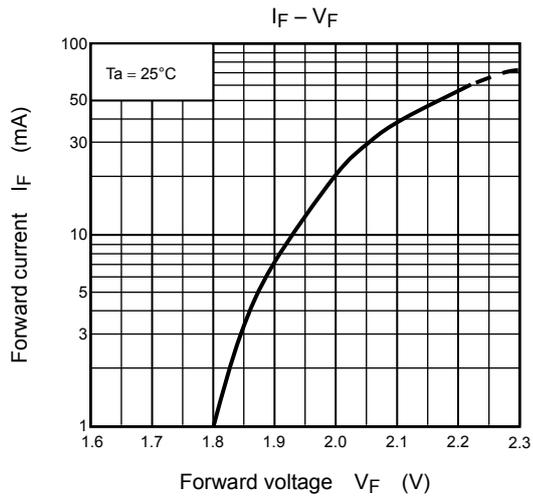


### Radiation pattern

$T_a = 25^\circ\text{C}$

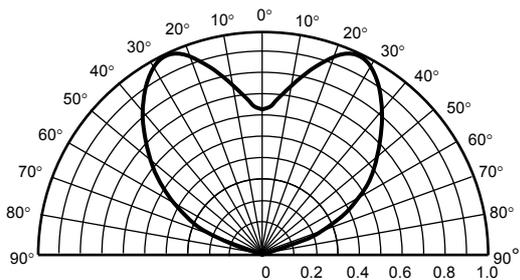


## TLGE60T(F)



### Radiation pattern

$T_a = 25^\circ\text{C}$



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